

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74AC283P, TC74AC283F, TC74AC283FN

4-Bit Binary Full Adder

The TC74AC283 is an advanced high speed CMOS 4-BIT BINARY FULL ADDER fabricated with silicon gate and double-layer metal wiring C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Sum (Σ) outputs are provided for each bit and a resultant carry (C4) is obtained from the fourth bit.

This adder features full internal look-ahead across all four bits.

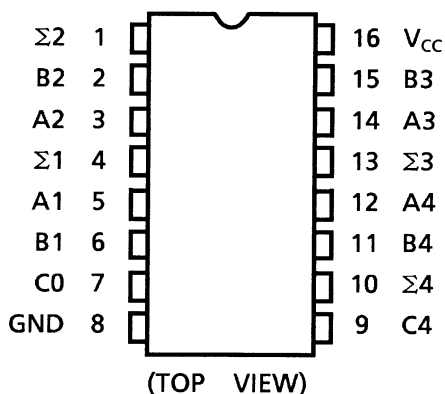
A4 × n bit binary adder is easily built up by cascading the AC283 without any additional logic.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

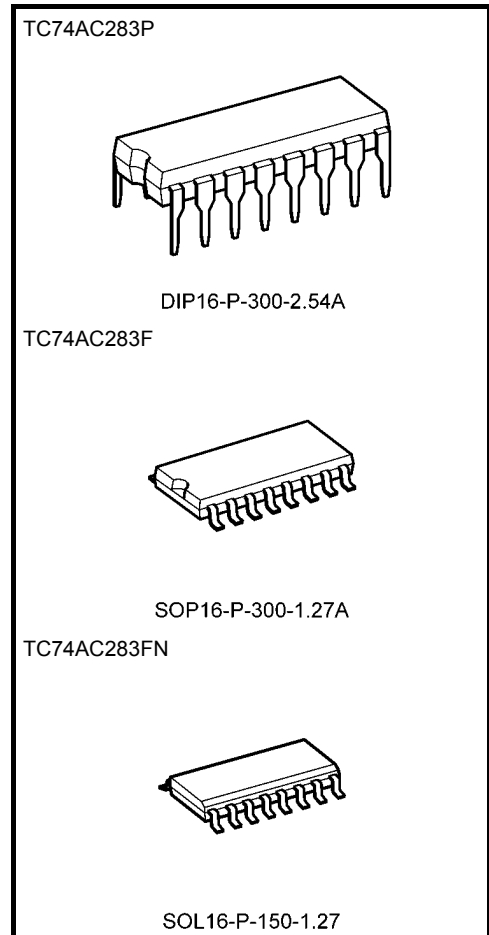
Features

- High speed: $t_{pd} = 7.0 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 8 \mu\text{A (max)}$ at $T_a = 25^\circ\text{C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC} \text{ (min)}$
- Symmetrical output impedance: $|I_{OH}| = I_{OL} = 24 \text{ mA (min)}$
Capability of driving 50Ω transmission lines.
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: $V_{CC} \text{ (opr)} = 2 \sim 5.5 \text{ V}$
- Pin and function compatible with 74F283

Pin Assignment



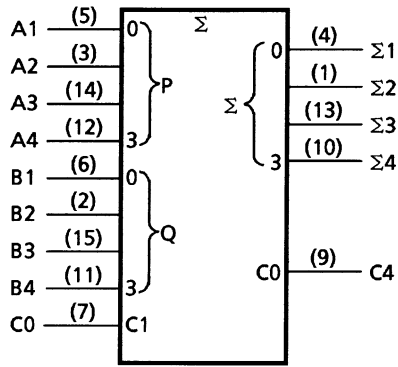
Note: xxxFN (JEDEC SOP) is not available in Japan.



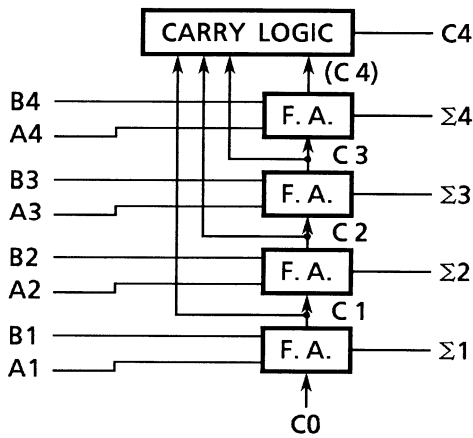
Weight

DIP16-P-300-2.54A	: 1.00 g (typ.)
SOP16-P-300-1.27A	: 0.18 g (typ.)
SOL16-P-150-1.27	: 0.13 g (typ.)

IEC Logic Symbol



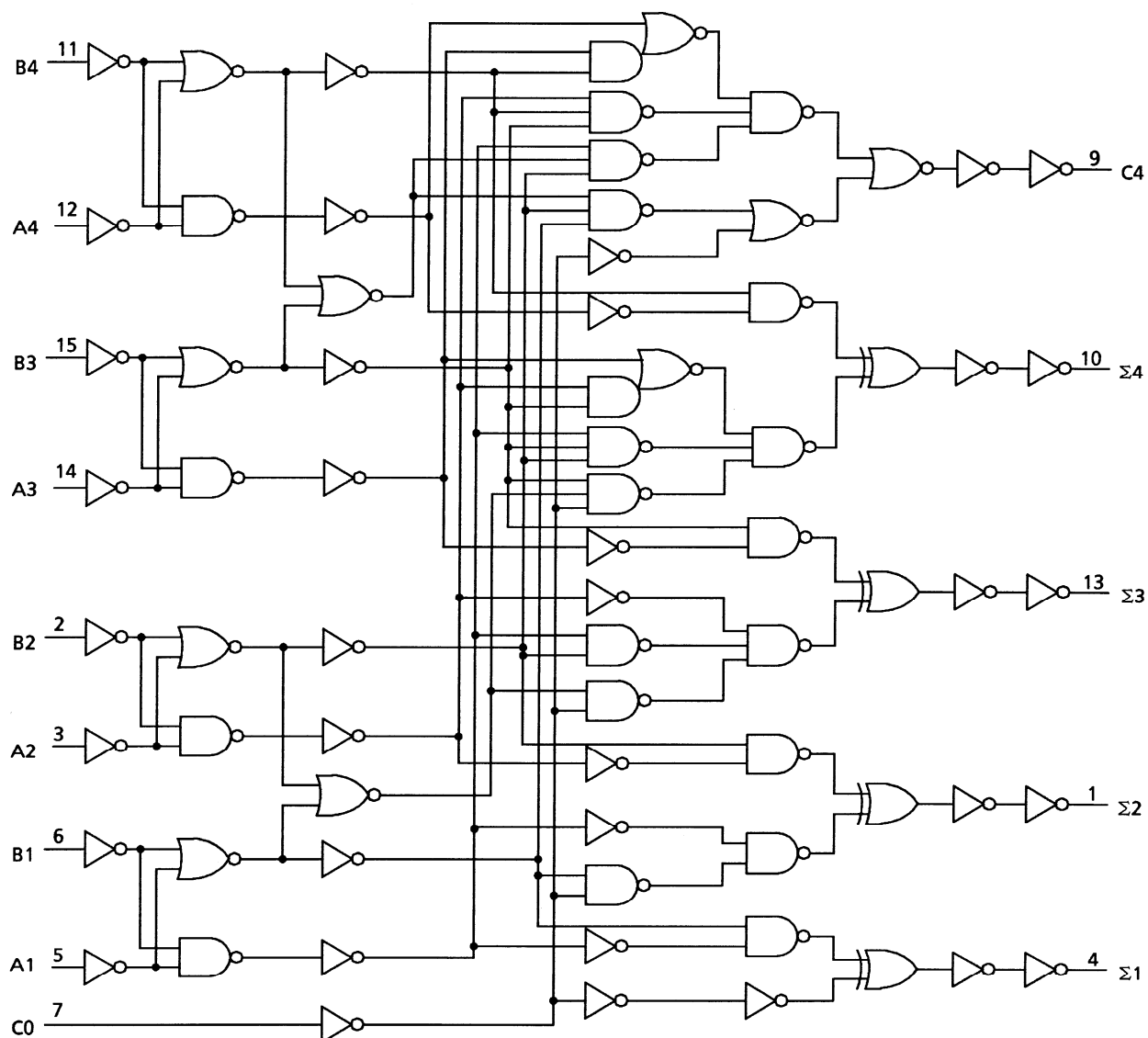
Block Diagram



Truth Table (1 bit)

Inputs			Outputs	
B _n	A _n	C _n – 1	Σ _n	C _n
L	L	L	L	L
L	L	H	H	L
L	H	L	H	L
L	H	H	L	H
H	L	L	H	L
H	L	H	L	H
H	H	L	L	H
H	H	H	H	H

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	$-0.5 \sim 7.0$	V
DC input voltage	V_{IN}	$-0.5 \sim V_{CC} + 0.5$	V
DC output voltage	V_{OUT}	$-0.5 \sim V_{CC} + 0.5$	V
Input diode current	I_{IK}	± 20	mA
Output diode current	I_{OK}	± 50	mA
DC output current	I_{OUT}	± 50	mA
DC V_{CC} /ground current	I_{CC}	± 125	mA
Power dissipation	P_D	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T_{stg}	$-65 \sim 150$	$^{\circ}\text{C}$

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 2: 500 mW in the range of $T_a = -40 \sim 65^{\circ}\text{C}$. From $T_a = 65$ to 85°C a derating factor of $-10 \text{ mW}/^{\circ}\text{C}$ should be applied up to 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	$2.0 \sim 5.5$	V
Input voltage	V_{IN}	$0 \sim V_{CC}$	V
Output voltage	V_{OUT}	$0 \sim V_{CC}$	V
Operating temperature	T_{opr}	$-40 \sim 85$	$^{\circ}\text{C}$
Input rise and fall time	dt/dV	$0 \sim 100$ ($V_{CC} = 3.3 \pm 0.3 \text{ V}$) $0 \sim 20$ ($V_{CC} = 5 \pm 0.5 \text{ V}$)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either VCC or GND.

Electrical Characteristics
DC Characteristics

Characteristics	Symbol	Test Condition		V _{CC} (V)	Ta = 25°C			Ta = -40~85°C		Unit
					Min	Typ.	Max	Min	Max	
High-level input voltage	V _{IH}	—		2.0 3.0 5.5	1.50 2.10 3.85	— — —	— — —	1.50 2.10 3.85	— — —	V
Low-level input voltage	V _{IL}	—		2.0 3.0 5.5	— — —	— — —	0.50 0.90 1.65	— — —	0.50 0.90 1.65	V
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	2.0	—	1.9	—	V
				3.0	2.9	3.0	—	2.9	—	
				4.5	4.4	4.5	—	4.4	—	
			I _{OH} = -4 mA I _{OH} = -24 mA I _{OH} = -75 mA (Note)	3.0	2.58	—	—	2.48	—	
				4.5	3.94	—	—	3.80	—	
				5.5	—	—	—	3.85	—	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	—	0.0	0.1	—	0.1	V
				3.0	—	0.0	0.1	—	0.1	
				4.5	—	0.0	0.1	—	0.1	
			I _{OL} = 12 mA I _{OL} = 24 mA I _{OL} = 75 mA (Note)	3.0	—	—	0.36	—	0.44	
				4.5	—	—	0.36	—	0.44	
				5.5	—	—	—	—	1.65	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		5.5	—	—	±0.1	—	±1.0	μA
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	—	—	8.0	—	80.0	μA

Note: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

AC Characteristics ($C_L = 50 \text{ pF}$, $R_L = 500 \Omega$, input: $t_r = t_f = 3 \text{ ns}$)

Characteristics	Symbol	Test Condition	$V_{CC} \text{ (V)}$	$T_a = 25^\circ\text{C}$			$T_a = -40 \sim 85^\circ\text{C}$		Unit
				Min	Typ.	Max	Min	Max	
Propagation delay time ($C0 \rightarrow \Sigma n$)	t_{pLH}	—	3.3 ± 0.3	—	10.6	17.5	1.0	20.0	ns
	t_{pHL}		5.0 ± 0.5	—	7.1	10.6	1.0	12.1	
Propagation delay time ($C0 \rightarrow C4$)	t_{pLH}	—	3.3 ± 0.3	—	9.4	15.5	1.0	17.7	ns
	t_{pHL}		5.0 ± 0.5	—	6.5	9.6	1.0	11.0	
Propagation delay time ($A_n, B_n \rightarrow \Sigma n$)	t_{pLH}	—	3.3 ± 0.3	—	12.1	20.2	1.0	23.0	ns
	t_{pHL}		5.0 ± 0.5	—	7.7	12.0	1.0	13.6	
Propagation delay time ($A_n, B_n \rightarrow C4$)	t_{pLH}	—	3.3 ± 0.3	—	11.6	19.3	1.0	22.0	ns
	t_{pHL}		5.0 ± 0.5	—	7.5	11.4	1.0	13.0	
Input capacitance	C_{IN}	—	—	—	5	10	—	10	pF
Power dissipation capacitance	C_{PD} (Note)	—	—	—	125	—	—	—	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

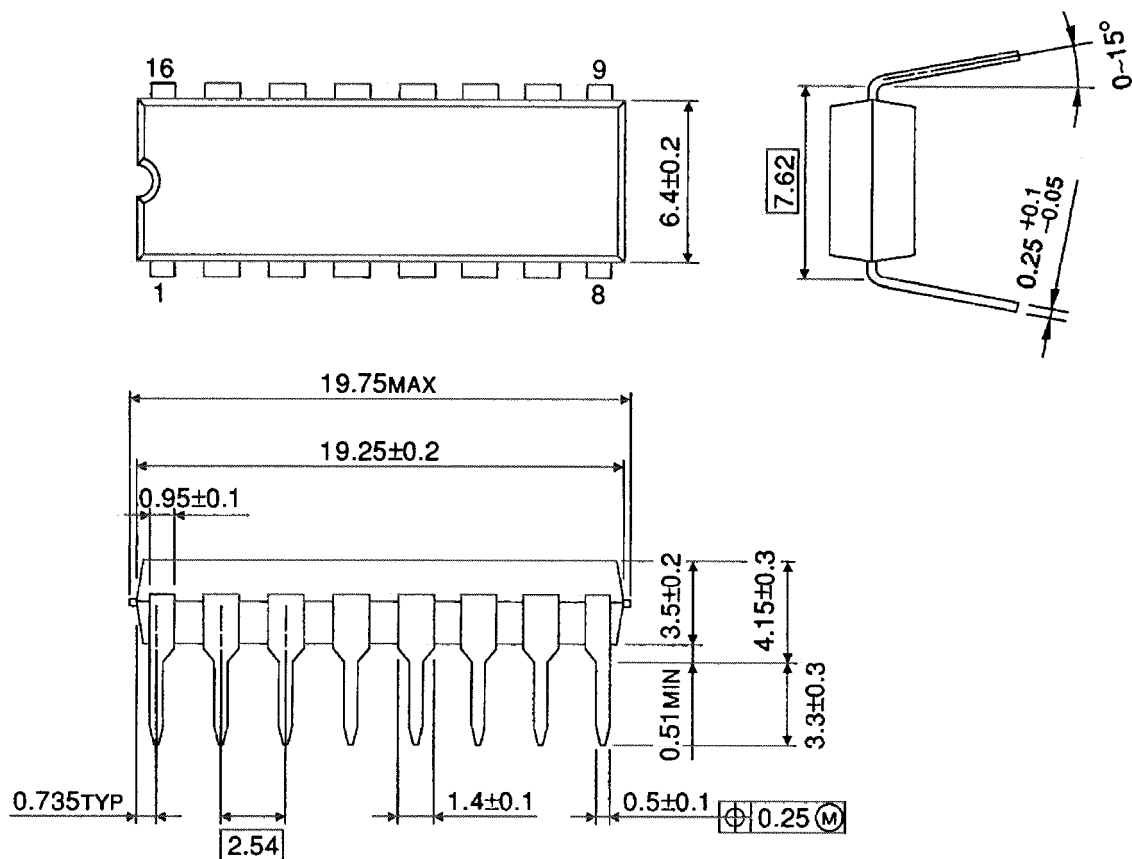
Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

Package Dimensions

DIP16-P-300-2.54A

Unit : mm

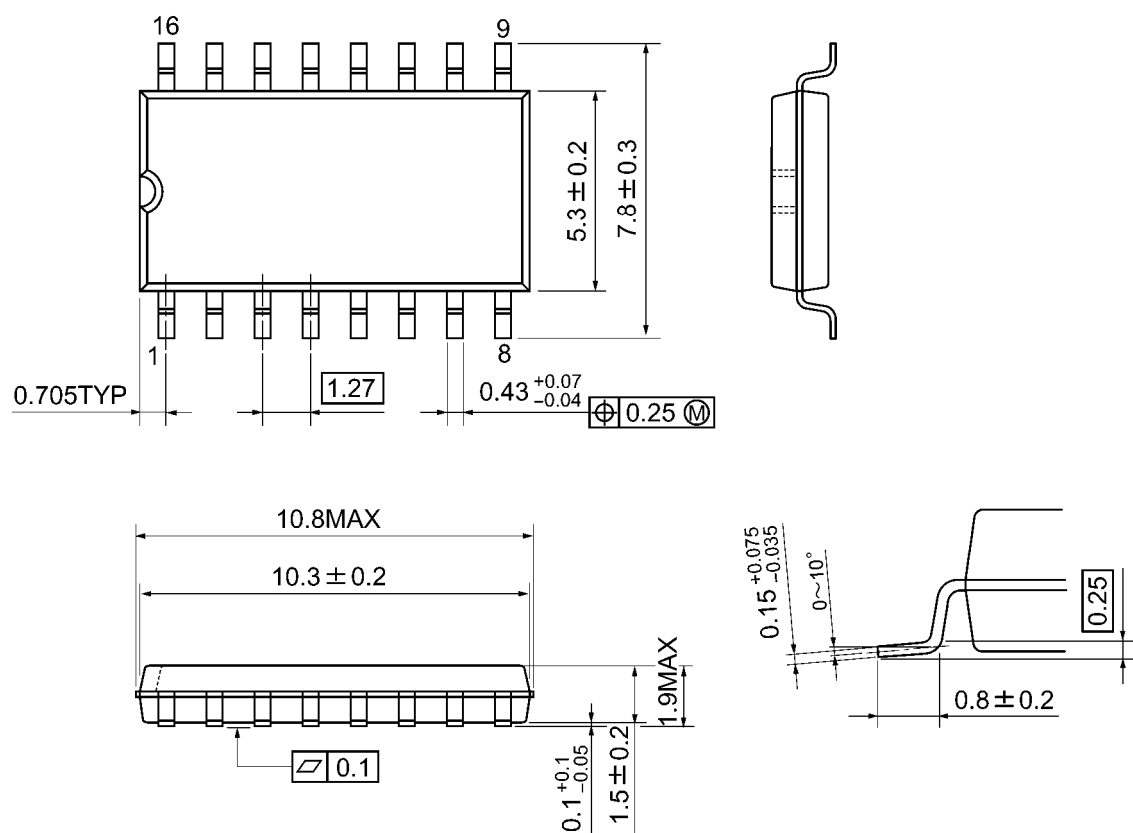


Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A

Unit: mm

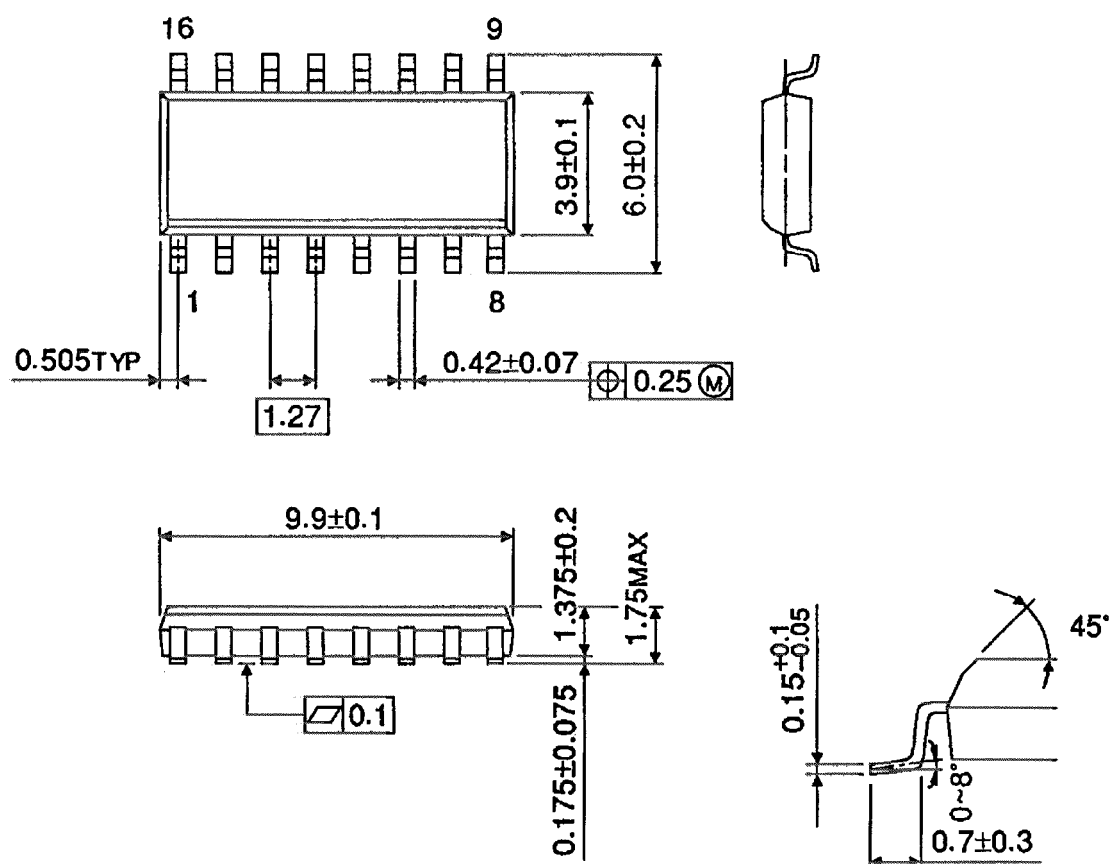


Weight: 0.18 g (typ.)

Package Dimensions (Note)

SOL16-P-150-1.27

Unit : mm



Note: This package is not available in Japan.

Weight: 0.13 g (typ.)

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